4N60-TC4 Power MOSFET

# 4A, 600V N-CHANNEL POWER MOSFET

## **■** DESCRIPTION

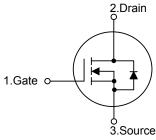
The UTC **4N60-TC4** is a N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology allows a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC **4N60-TC4** is generally applied in high efficiency switch mode power supplies.



- \*  $R_{DS(ON)} \le 2.6\Omega$  @  $V_{GS} = 10V$ ,  $I_D = 2.0A$
- \* High Switching Speed

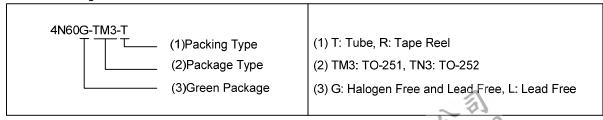
#### ■ SYMBOL



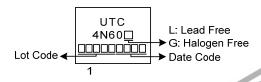
## ■ ORDERING INFORMATION

Ordering Number		Pin	Assignr	Dooking		
Halogen Free	Package	1	2	3	Packing	
4N60G-TM3-T	TO-251	G	D	S	Tube	
4N60G-TN3-R	TO-252	G	D	S	Tape Reel	
!	Halogen Free 4N60G-TM3-T	Halogen Free 4N60G-TM3-T TO-251	Halogen Free 1 4N60G-TM3-T TO-251 G	Halogen Free         Package         1         2           4N60G-TM3-T         TO-251         G         D	Halogen Free         Package         1         2         3           4N60G-TM3-T         TO-251         G         D         S	

Note: Pin Assignment: G: Gate D: Drain S: Source



## **■ MARKING**



TO-251

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## ■ ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		$V_{DSS}$	600	V	
Gate-Source Voltage		$V_{GSS}$	± 30	V	
Drain Current	Continuous	$I_{D}$	4	Α	
	Pulsed (Note 2)	$I_{DM}$	8	Α	
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	42.1	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	3.2	V/ns	
Power Dissipation		$P_D$	50	W	
Junction Temperature		$T_J$	+150	°C	
Storage Temperature		T <sub>STG</sub>	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 10mH,  $I_{AS}$  = 2.9A,  $V_{DD}$  = 50V,  $R_G$  = 25  $\Omega$  Starting  $T_J$  = 25°C
- 4.  $I_{SD} \le 4A$ , di/dt  $\le 100A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$

## **■ THERMAL DATA**

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	$\theta_{JA}$	°C/W	
Junction to Case	$\theta_{JC}$	2.5 (Note)	°C/W

Note: Device mounted on FR-4 substrate P<sub>C</sub> board, 2oz copper, with 1inch square copper plate.



## **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C, unless otherwise specified)

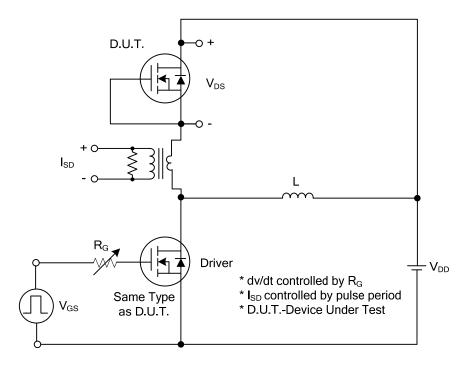
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		$BV_{DSS}$	$V_{GS}$ =0V, $I_{D}$ = 250 $\mu$ A	600			V
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =600V, V <sub>GS</sub> =0V			10	μΑ
Gate-Source Leakage Current	Forward	I <sub>GSS</sub>	$V_{GS}$ =30V, $V_{DS}$ =0V			100	nA
	Reverse		$V_{GS}$ =-30V, $V_{DS}$ =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_D=250\mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	$V_{GS}$ =10V, $I_D$ =2.0A			2.6	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance	nput Capacitance				505		pF
Output Capacitance		C <sub>ISS</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1.0 MHz		53.5		pF
Reverse Transfer Capacitance	Reverse Transfer Capacitance				2.9		pF
SWITCHING CHARACTERISTICS	3						
Total Gate Charge (Note 1)		$Q_G$	\/ -400\/ \/ -40\/   -40		11.5		nC
Gateource Charge		$Q_GS$	V <sub>DS</sub> =480V, V <sub>GS</sub> =10V, I <sub>D</sub> =4A I <sub>G</sub> =1mA (Note 1, 2)		3.6		nC
Gate-Drain Charge		$Q_GD$	IG-IIIA (Note 1, 2)		1.6		nC
Turn-on Delay Time (Note 1)		$t_{D(ON)}$			6		ns
Rise Time		$t_R$	$V_{DS}$ =100V, $V_{GS}$ =10V, $I_{D}$ =4A,		15.7		ns
Turn-off Delay Time		t <sub>D(OFF)</sub>	R <sub>G</sub> =25Ω (Note 1, 2)		36		ns
all-Time		$t_{F}$			24.5		ns
SOURCE- DRAIN DIODE RATING	S AND CH	ARACTERIST	TICS				
Maximum Continuous Drain-Source Diode						4	Α
Forward Current		Is				4	^
Maximum Pulsed Drain-Source Diode		la				8	Α
Forward Current		I <sub>SM</sub>				O	^
Drain-Source Diode Forward Voltage (Note 1)		$V_{SD}$	I <sub>S</sub> =4A, V <sub>GS</sub> =0V			1.4	V
Reverse Recovery Time (Note 1)		$t_{rr}$	I <sub>S</sub> =4A, V <sub>GS</sub> =0V		252		ns
Reverse Recovery Charge		Q <sub>rr</sub>	dI <sub>F</sub> /dt=100A/μs (Note1)		1.9		μC

Notes: 1. Pulse Test : Pulse width  $\leq$  300 $\mu$ s, Duty cycle  $\leq$  2%.

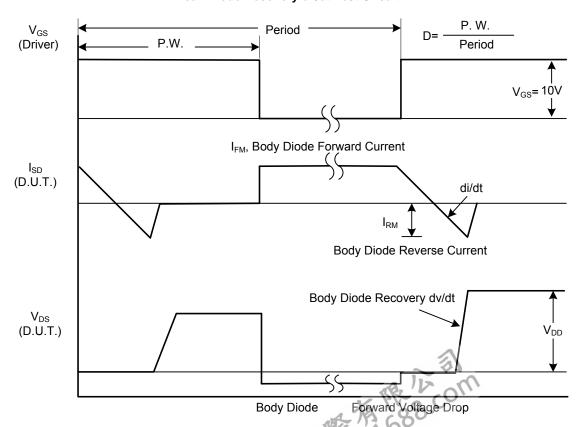


<sup>2.</sup> Essentially independent of operating temperature.

## **■ TEST CIRCUITS AND WAVEFORMS**



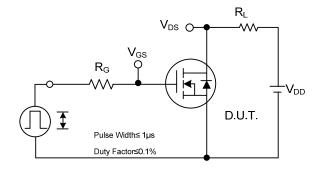
## Peak Diode Recovery dv/dt Test Circuit

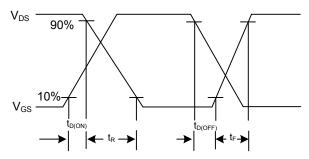


Peak Diode Recovery dv/dt Waveforms

4N60-TC4 **Power MOSFET** 

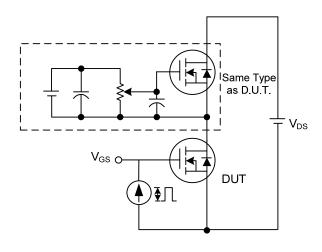
## **TEST CIRCUITS AND WAVEFORMS**

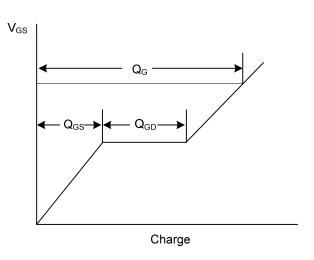




**Switching Test Circuit** 

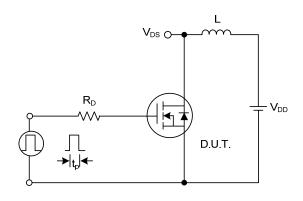
**Switching Waveforms** 

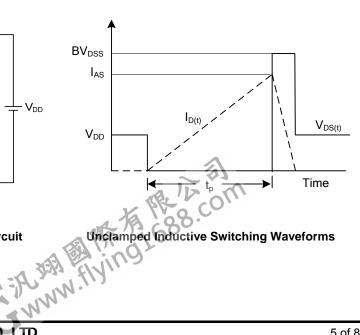




**Gate Charge Test Circuit** 

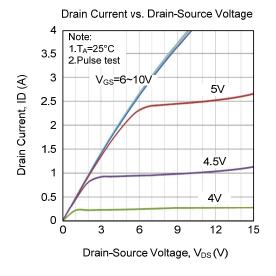
**Gate Charge Waveform** 

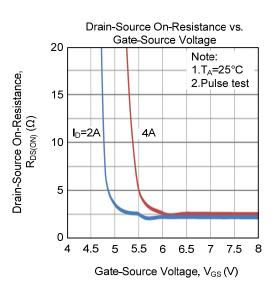


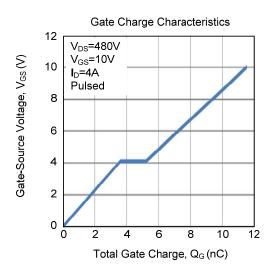


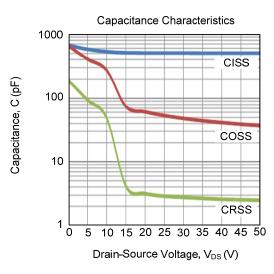
**Unclamped Inductive Switching Test Circuit** 

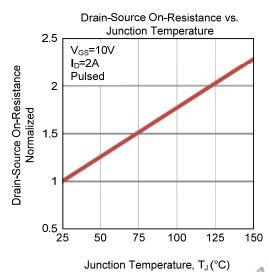
#### **■ TYPICAL CHARACTERISTICS**

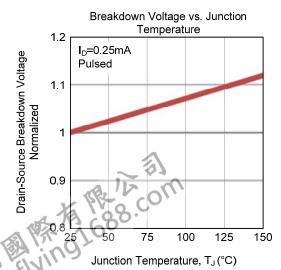




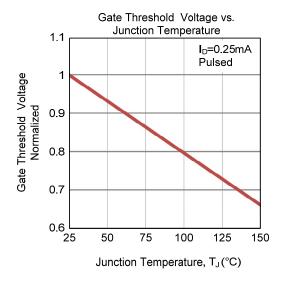


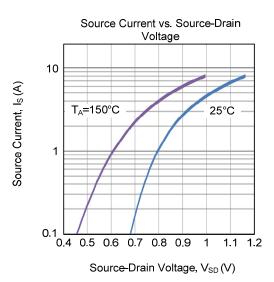


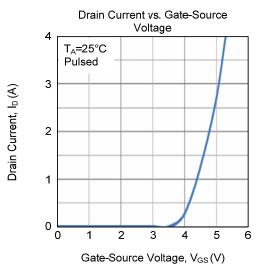


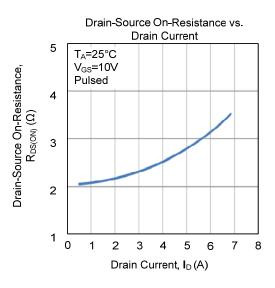


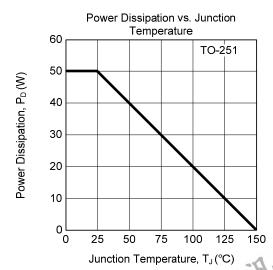
## **■ TYPICAL CHARACTERISTICS (Cont.)**

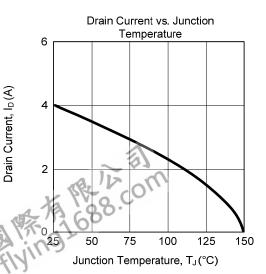




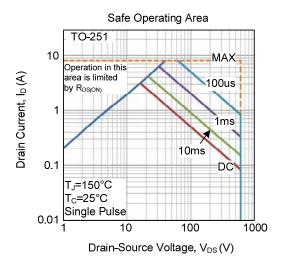








## **■ TYPICAL CHARACTERISTICS (Cont.)**



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